

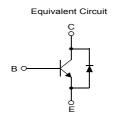
July 2010

FJD5304D High Voltage Fast Switching Transistor

Features

- · Built-in Free Wheeling Diode
- · Wide Safe Operating Area
- · Small Variance in Storage Time
- · Suitable for Electronic Ballast Application





Absolute Maximum Ratings $T_a = 25$ °C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage	700	V
V _{CEO}	Collector-Emitter Voltage	400	V
V _{EBO}	Emitter-Base Voltage	12	V
I _C	Collector Current (DC)	4	A
I _{CP}	* Collector Current (Pulse)	8	A
I _B	Base Current (DC)	2	A
I _{BP}	* Base Current (Pulse)	4	A
P _C	Collector Dissipation $T_c = 20$ $T_a = 20$	5°C 30 5°C 1.25	W W
T _J	Junction Temperature	150	°C
T _{STG}	Storage Temperature	-55 to 150	°C

^{*} Pulse Test: PW = $300\mu s$, Duty Cycle = 2% Pulsed

Thermal Characteristics $T_a = 25$ °C unless otherwise noted

Symbol	Parameter	Value	Units
$R_{\theta ja}$	Thermal Resistance Junction-Ambient **	99	°C/W

^{**} Device mounted on minimum pad size.

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
J5304D	FJD5304DTM	D-PAK	13" Dia	-	2500
J5304D	FJD5304DTF	D-PAK	13" Dia	-	2000

Electrical Characteristics $T_a = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
BV _{CBO}	Collector-Base Breakdown Voltage	I _C = 1mA, I _E = 0	700			V
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_C = 5mA$, $I_B = 0$	400			V
BV _{EBO}	Emitter-Base Breakdown Voltage	$I_E = 1 \text{mA}, I_C = 0$	12			V
I _{CES}	Collector Cut-off Current	V _{CB} = 700V, I _E = 0			100	μΑ
I _{CEO}	Collector Cut-off Current	V _{CB} = 400V, I _B = 0			250	μΑ
I _{EBO}	Emitter Cut-off Current	V _{EB} = 12V, I _C = 0			1	mA
h _{FE}	DC Current Gain	$V_{CE} = 5V, I_{C} = 10mA$ $V_{CE} = 5V, I_{C} = 2.0A$	10 8		40	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_C = 0.5A, I_B = 0.1A$			0.7	V
		I _C = 1.0A, I _B = 0.2A			1.0	V
		$I_C = 2.5A, I_B = 0.5A$			1.5	V
V _{BE(sat)}	Base-Emitter Saturation Voltage	$I_C = 0.5A, I_B = 0.1A$			1.1	V
		I _C = 1.0A, I _B = 0.2A			1.2	V
		I _C = 2.5A, I _B = 0.5A			1.3	V
t _{STG}	Storage Time	V _{CLAMP} =200V, I _C =2.0A,		0.6		μS
t _F	Fall Time	I _{B1} =0.4A, V _{BE} (off)=-5V, L=200μH		0.1		μS
t _{STG}	Storage Time	V _{CC} =250V, I _C =2.0A,			2.9	μS
t _F	Fall Time	I _{B1} =0.4A, I _{B2} =-0.4A, T _P =30μs		0.2		μS
V _F	Diode Forward Voltage	I _F = 2A			2.5	V

Typical Performance Characteristics

Figure 1. Static Characteristic

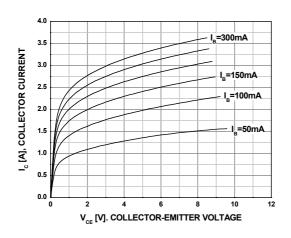


Figure 2. DC Current Gain

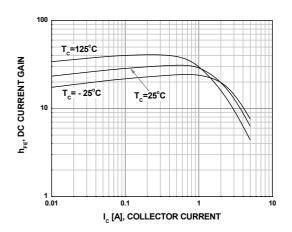


Figure 3. Collector-Emitter Saturation Voltage

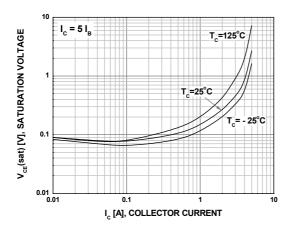


Figure 4. Base-Emitter Saturation Voltage

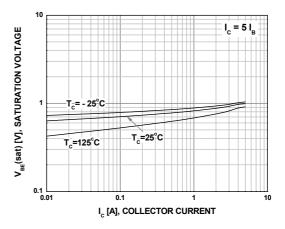


Figure 5. Resistive Load Switching Time

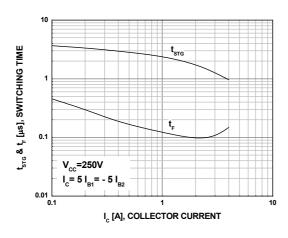
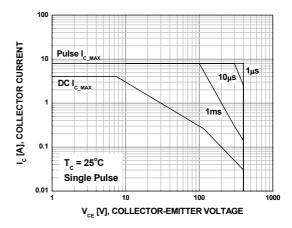


Figure 6. Forward Biased Safe Operating Area



Typical Performance Characteristics (Continued)

Figure 7. Reverse Biased Safe Operating Area

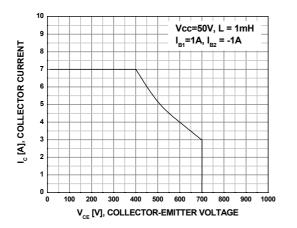
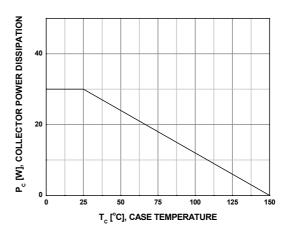
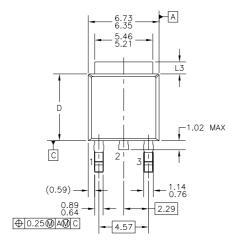


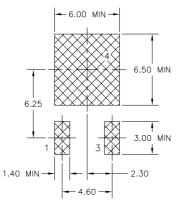
Figure 8. Power Derating Curve



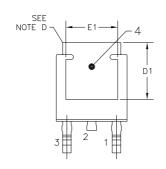
Mechanical Dimensions

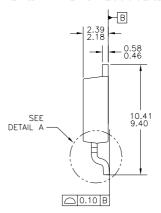
D-PAK

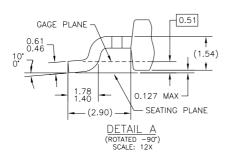




LAND PATTERN RECOMMENDATION







- NOTES: UNLESS OTHERWISE SPECIFIED

 A) ALL DIMENSIONS ARE IN MILLIMETERS.

 B) THIS PACKAGE CONFORMS TO JEDEC, TO-252, ISSUE C, VARIATION AA & AB, DATED NOV. 1999.

 C) DIMENSIONING AND TOLERANCING PER ASME '14.5M-1994.

 D) HEAT SINK TOP EDGE COULD BE IN CHAMFERED CORNERS OR EDGE PROTRUSION.

 E) DIMENSIONS L3,D,E1&D1 TABLE:

 [OPTION AA | OPTION AB]

	OPTION AA	OPTION AB
L3	0.89-1.27	1.52-2.03
D	5.97-6.22	5.33-5.59
E1	4.32 MIN	3.81 MIN
D1	5.21 MIN	4.57 MIN

PRESENCE OF TRIMMED CENTER LEAD IS OPTIONAL.

Dimensions in Millimeters





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Definition of Terms

Definition of Terms				
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No Identification Needed	ded Full Production Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make chang at any time without notice to improve the design.			
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